

Feature

- Fixed Output Voltage: 5V
- Wide Input Operation Voltage Range: 8V to 38V
- Absolute Maximum Input Supply Voltage: 40V
- Input Protection Mode Trigger Voltage: 32V
- Up to 93% Efficiency
- Fixed Switching Frequency: 130kHz
- ON/OFF Control
- No Loop Compensation Required
- Programmable current limit
- Thermal Shutdown
- Available in SOP-8L Package

Application

- Car Charger / Adaptor
- Pre-Regulator for Linear Regulators
- Distributed Power Systems
- Battery Charger

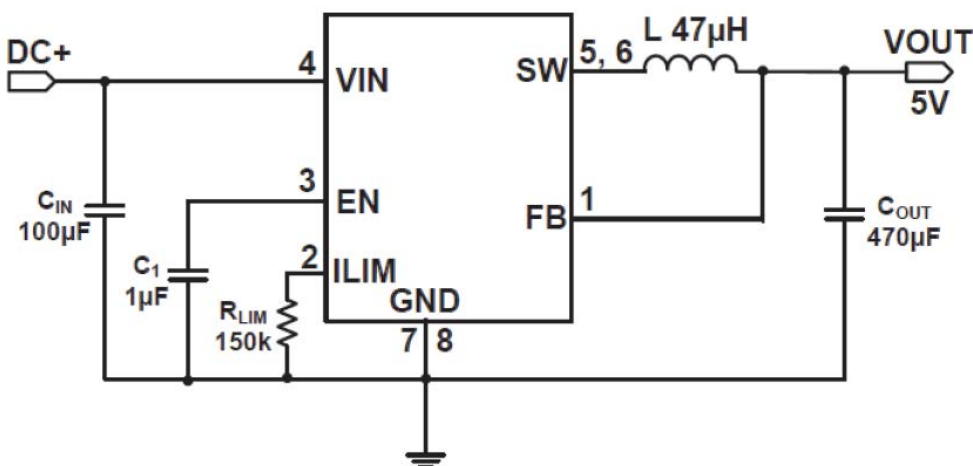
Description

The HM1382A is a synchronous step down regulator from a high voltage input supply. Operating with a wide input voltage range, the HM1382A achieves 2.5A continuous output current with excellent load and line regulation. The switching frequency is fixed 130 kHz and the synchronous architecture provides for highly efficient designs. Current mode operation provides fast transient response and eases loop stabilization.

The HM1382A requires a minimum number of readily available standard external components. Other features include cable compensation, programmable current limit and thermal shutdown.

The HM1382A converters are available in the industry standard SOP-8L packages.

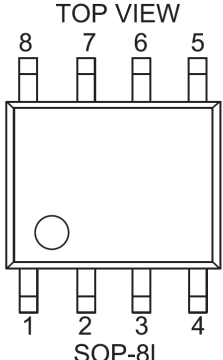
Typical Application Circuit



* The output voltage is fixed 5V.

* ILIM: HM1382A can work when keeping ILIM pin floating, with 1.8A limit current in this situation.

Pin Assignment and Description

 <p>TOP VIEW</p> <p>8 7 6 5</p> <p>1 2 3 4</p> <p>SOP-8L</p>	PIN	NAME	DESCRIPTION
	1	FB	Feedback
	2	ILIM	Current Limit
	3	EN	ON/OFF Control
	4	VIN	Input Supply Voltage
	5, 6	SW	Switch Node
	7, 8	GND	Ground

Absolute Maximum Ratings (Note 1)

- Input Supply Voltage-0.3V ~ 40V
- FB, ILIM, EN Voltages..... -0.3V ~ 6V
- SW Voltage-0.3V ~ ($V_{IN} + 1V$)
- Operating Temperature Range (Note 2).....-40°C ~ +85°C
- Storage Temperature Range..... -65°C ~ +150°C
- Junction Temperature Range.....+150°C
- Lead Temperature (Soldering, 10 sec.)..... +265°C

Note 1: Stresses beyond those listed Absolute Maximum Ratings may cause permanent damage to the device. Exposure to any Absolute Maximum Rating condition for extended periods may affect device reliability and lifetime.

Note 2: The HM1382A is guaranteed to meet performance specifications from 0°C to 70°C. Specifications over the -40°C to 85°C operating temperature range are assured by design, characterization and correlation with statistical process controls.

Electrical Characteristics

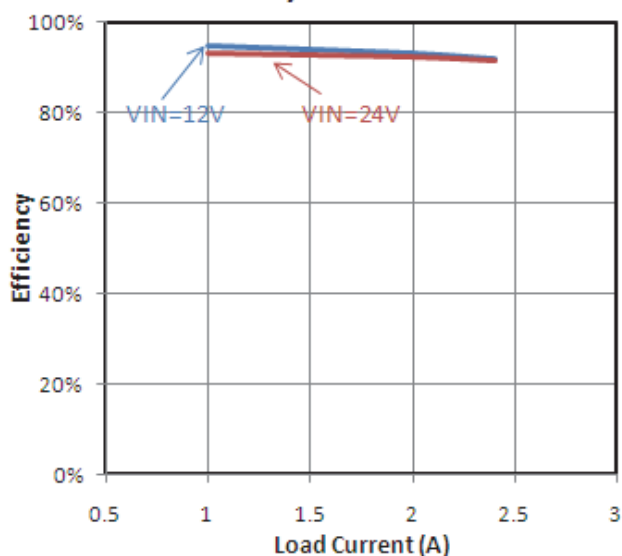
Operating Conditions: $T_A=25^{\circ}\text{C}$, $V_{IN}=12\text{V}$, unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
V_{IN}	Input Voltage Range		8		38	V
$V_{IN-P-Trigger}$	Input Protection Mode Trigger Voltage			32		V
V_{OUT}	Output Voltage Range	$I_{OUT}=10\text{mA}$	4.9		5.2	V
I_Q	Quiescent Current	$I_{LOAD}=0\text{A}$		10		mA
I_{SHDN}	Shutdown Current			110	150	μA
V_{UVLO}	Input UVLO Threshold			4.25	4.5	V
ΔV_{UVLO}	UVLO Hysteresis			50	100	mV
I_{FB}	Feedback Pin Input Current			0.05		μA
f_{OSC}	Oscillator Frequency			130		kHz
DC	Max Duty Cycle				90	%
I_{LIM}	Limit Current	$R_{LIMIT} = 150\text{k}$		3.0		A
I_{LIM_def}	Default Limit Current	Float ILIM Pin		1.8		A
I_{LIM-TH}	Current Limit Sense Pin Source Current		7	8.5	10	μA
T_{SD}	Thermal Shutdown	Temperature Rising		145		$^{\circ}\text{C}$
ΔT_{SD}	Thermal Shutdown Hysteresis			30		$^{\circ}\text{C}$

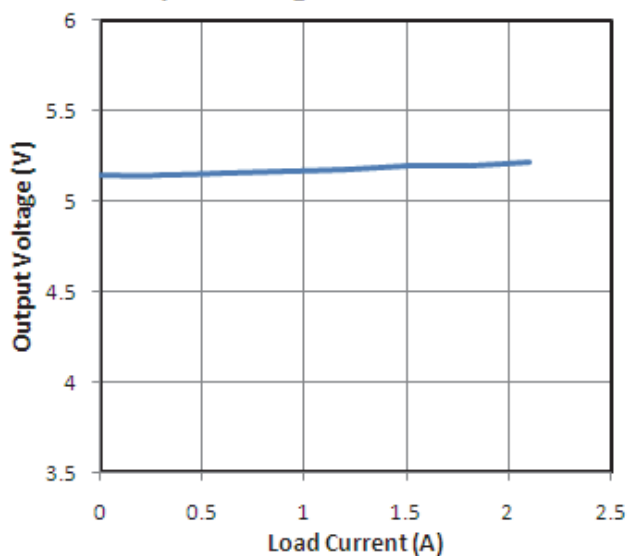
Typical Performance Characteristics

Operating Conditions: $T_A=25^{\circ}\text{C}$, $C_{IN}=100\mu\text{F}$, $C_{OUT}=470\mu\text{F}$, $L=47\mu\text{H}$, unless otherwise specified.

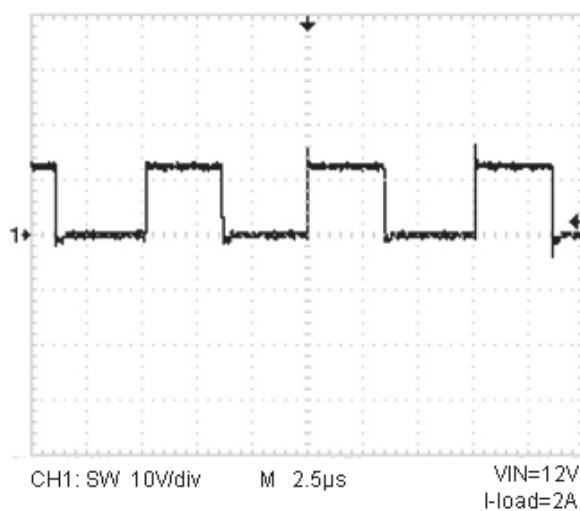
Efficiency vs. Load Current



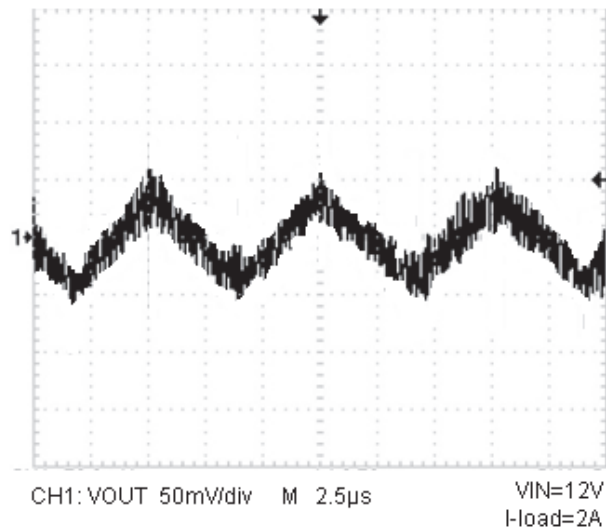
Output Voltage vs. Load Current



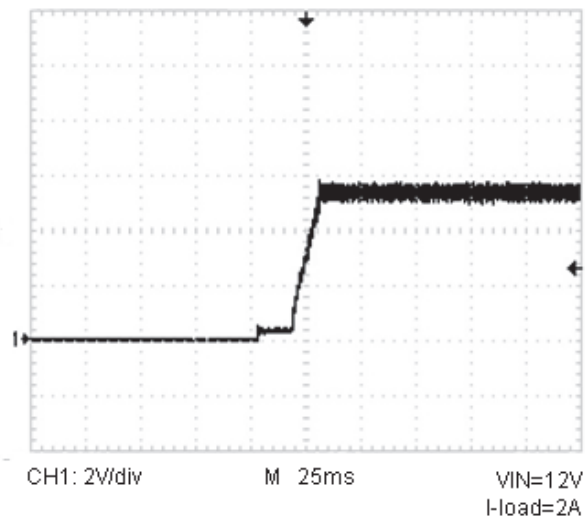
SW Waveform



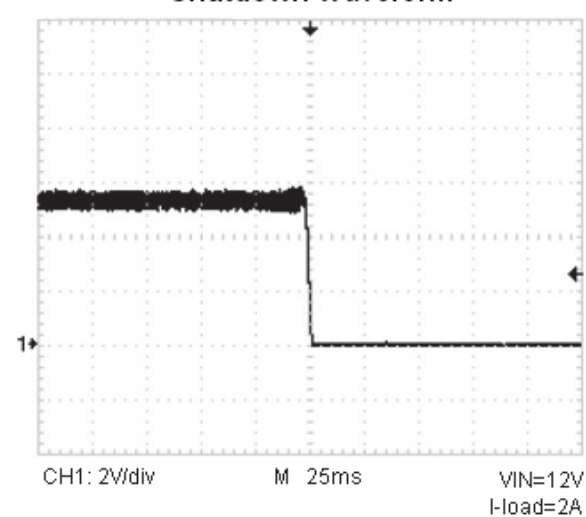
Output Ripple



Start-up Waveform



Shutdown Waveform



Pin Functions

FB (Pin 1): Feedback Pin. In HM1382A, the output voltage is fixed.

ILIM (Pin 2): Monitors current through the low-side switch and triggers current limit operation if the inductor valley current exceeds a user defined value that is set by R_{LIM} and the Sense current sourced out of this pin during operation.

EN (Pin 3): En Control Input. Forcing this pin above 3.6V enables the part. Forcing this pin below 1.5V can shuts down the device. Do not leave EN floating.

VIN (Pin 4): Main Supply Pin. It must be closely decoupled to GND, with a 100 μ F or greater ceramic capacitor to prevent large voltage spikes from appearing at the input.

SW (Pin 5, 6): Switch Node Connection to Inductor.

GND (Pin 7, 8): Ground Pin.

Application Information

Thermal Protection

The total power dissipation in HM1382A is limited by a thermal protection circuit. When the device temperature rises to approximately 145°C, this circuit turns off the output, allowing the IC to cool. The thermal protection circuit can protect the device from being damaged by overheating in the event of fault conditions. Continuously running the HM1382A into thermal shutdown degrades device reliability.

Inductor Selection

For most applications, the value of the inductor will fall in the range of 10μH to 47μH. Its value is chosen based on the desired ripple current. Large value inductors lower ripple current and small value inductors result in higher ripple currents. Higher V_{IN} or V_{OUT} also increases the ripple current and value inductors result in higher ripple currents. Higher V_{IN} or V_{OUT} also increases the ripple current as shown in equation. A reasonable starting point for setting ripple current is $\Delta I_L = 1000\text{mA}$ (40% of 2.5A).

$$\Delta I_L = \frac{1}{(f)(L)} V_{OUT} \left(1 - \frac{V_{OUT}}{V_{IN}} \right)$$

The DC current rating of the inductor should be at least equal to the maximum load current plus half the ripple current to prevent core saturation. Thus,

a 3.0A rated inductor should be enough for most applications (2.5A + 500mA). For better efficiency, choose a low DC-resistance inductor.

Different core materials and shapes will change the size/current and price/current relationship of an inductor. Toroid or shielded pot cores in ferrite or perm alloy materials are small and don't radiate much energy, but generally cost more than powdered iron core inductors with similar electrical characteristics. The choice of which style inductor to use often depends more on the price vs. size requirements and any radiated field/EMI requirements than on what the HM1382A requires to operate.

Current Limit

Current limit detection occurs during the off-time by monitoring the current through the low-side switch using an external resistor, R_{LIM} . The current limit value is defined by R_{LIM} . If during the off-time the

current in the low-side switch exceeds the user defined current limit value, the next on-time cycle is immediately terminated. Current sensing is achieved by comparing the voltage across the low side FET with the voltage across the current limit set resistor R_{LIM} . Choose the proper limit resistance values refer to the equation. (Data from equation tests on the dedicated board layout at $T=25^\circ\text{C}$. In practical, the current limit will change with temperature variation.) The current limit rises when the limit resistance R_{LIM} rises, use the equation below:

$$R_{LIM} (\text{k}\Omega) = 40 \cdot I_{MAX} (\text{A}) \text{ (approximation)}$$

When $R_{LIM} = 150\text{k}$, the current limit value is 3.0A .

Output and Input Capacitor Selection

In continuous mode, the source current of the top MOSFET is a square wave of duty cycle V_{OUT}/V_{IN} . To prevent large voltage transients, a low ESR input capacitor sized for the maximum RMS current must be used. The maximum RMS capacitor current is given by:

$$C_{IN} \text{ required } I_{RMS} \approx I_{OMAX} \frac{[V_{OUT}(V_{IN} - V_{OUT})]^{1/2}}{V_{IN}}$$

This formula has a maximum at $V_{IN} = 2V_{OUT}$, where $I_{RMS} = I_{OUT}/2$. This simple worst-case condition is commonly used for design because even significant deviations do not offer much relief. Note that the capacitor manufacturer's ripple current ratings are often based on 2000 hours of life. This makes it advisable to further derate the capacitor, or choose a capacitor rated at a higher temperature than required. Always consult the manufacturer if there is any question.

The selection of C_{OUT} is driven by the required effective series resistance (ESR). Typically, once the ESR requirement for C_{OUT} has been met, the RMS current rating generally far exceeds the $I_{RIPPLE(P-P)}$ requirement. The output ripple ΔV_{OUT} is determined by:

$$\Delta V_{OUT} \approx \Delta I_L \left(\text{ESR} + \frac{1}{8fC_{OUT}} \right)$$

Where f = operating frequency, C_{OUT} = output capacitance and ΔI_L = ripple current in the inductor. For a fixed output voltage, the output ripple is highest at maximum input voltage since ΔI_L increases with input voltage.

Aluminum electrolytic and dry tantalum capacitors are both available in surface mount configurations. In the case of tantalum, it is critical that the capacitors are surge tested for use in switching power supplies. An excellent choice is the AVX TPS series of surface mount tantalum. These are specially constructed and tested for low ESR so they give the lowest ESR for a given volume.

Efficiency Considerations

The efficiency of a switching regulator is equal to the output power divided by the input power times 100%. It is often useful to analyze individual losses to determine what is limiting the efficiency and which change would produce the most improvement. Efficiency can be expressed as: Efficiency = 100% - (L1 + L2 + L3 + ...) where L1, L2, etc. are the individual losses as a percentage of input power. Although all dissipative elements in the circuit produce losses, two main sources usually account for most of the losses: V_{IN} quiescent current and I^2R losses. The V_{IN} quiescent current loss dominates the efficiency loss at very low load currents whereas the I^2R loss dominates the efficiency loss at medium to high load currents. In a typical efficiency plot, the efficiency curve at very low load currents can be misleading since the actual power lost is of no consequence.

1. The V_{IN} quiescent current is due to two components: the DC bias current as given in the electrical characteristics and the internal main switch. The HM1382A operates by a constant frequency, and synchronous switch gate charge currents. The gate charge current results from switching the gate capacitance of the internal power MOSFET switches. Each time the gate is switched from high to low to high again, a packet of charge ΔQ moves from V_{IN} to ground. The resulting $\Delta Q/\Delta t$ is the current out of V_{IN} that is typically larger than the DC bias current. Both the DC bias and gate charge losses are . In continuous mode, $I_{GATECHG} = f(Q_T + Q_B)$ where Q_T and Q_B are the gate charges of the internal top and bottom switches. Both the DC bias and gate charge losses are proportional to V_{IN} and thus their effects will be more pronounced at higher supply voltages.

2. I^2R losses are calculated from the resistances of the internal switches, R_{SW} and external inductor R_L . In continuous mode the average output current flowing through inductor L is “chopped” between

the main switch and the synchronous switch. Thus, the series resistance looking into the SW pin is a function of both top and bottom MOSFET $R_{DS(ON)}$ and the duty cycle (DC) as follows: $R_{SW} = R_{DS(ON)TOP} \times DC + R_{DS(ON)BOT} \times (1-DC)$ The $R_{DS(ON)}$ for both the top and bottom MOSFETs can be obtained from the Typical Performance Characteristics curves. Thus, to obtain I^2R losses, simply add R_{SW} to R_L and multiply the result by the square of the average output current. Other losses including C_{IN} and C_{OUT} ESR dissipative losses and inductor core losses generally account for less than 2% of the total loss.

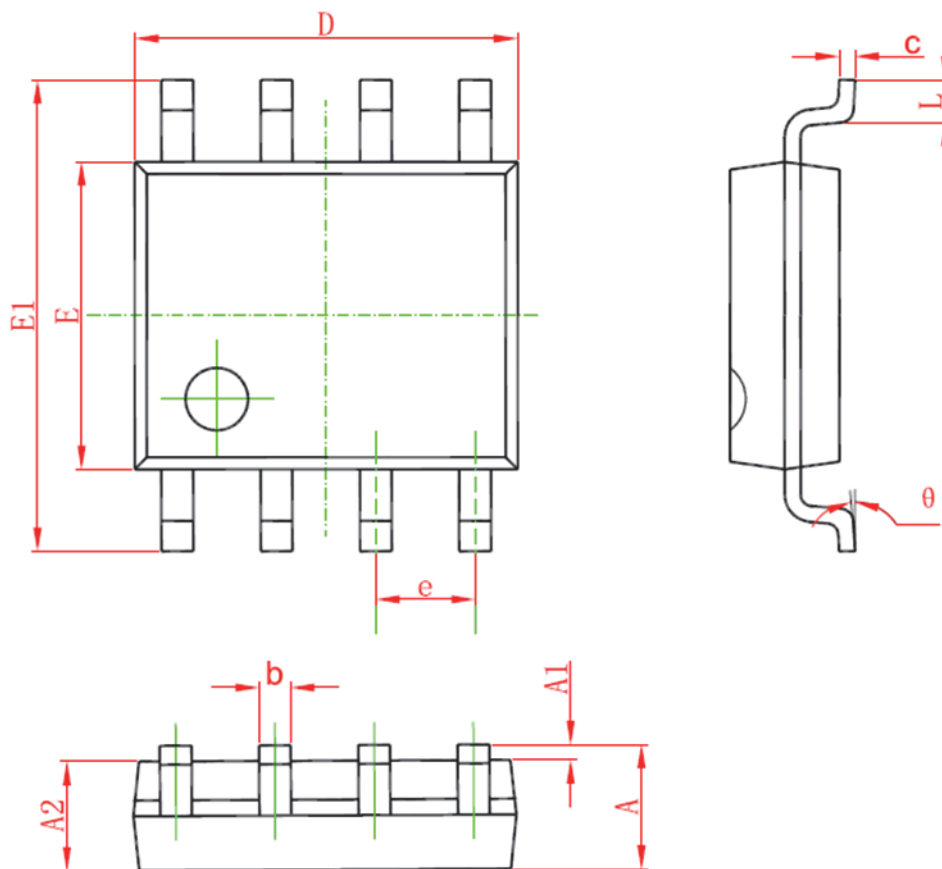
Board Layout Suggestions

When laying out the printed circuit board, the following checklist should be used to ensure proper operation of the HM1382A. Check the following in your layout.

1. The power traces, consisting of the GND trace, the SW trace and the V_{IN} trace should be kept short, direct and wide.
2. Put the input capacitor as close as possible to the device pins (V_{IN} and GND).
3. SW node is with high frequency voltage swing and should be kept small area. Keep analog components away from SW node to prevent stray capacitive noise pick-up.
4. Connect all analog grounds to a command node and then connect the command node to the power ground behind the output capacitors.

Packaging Information

SOP-8L Package Outline Dimension



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	1.350	1.750	0.053	0.069
A1	0.100	0.250	0.004	0.010
A2	1.350	1.550	0.053	0.061
b	0.330	0.510	0.013	0.020
c	0.170	0.250	0.006	0.010
D	4.700	5.100	0.185	0.200
E	3.800	4.000	0.150	0.157
E1	5.800	6.200	0.228	0.244
e	1.270(BSC)		0.050(BSC)	
L	0.400	1.270	0.016	0.050
θ	0°	8°	0°	8°